

15 V CMOS Dual Buffered Multiplying 8-Bit Digital-to-Analog Converter

#### **FEATURES**

- Very Low Total Harmonic Distortion
- Lower Glitch Energy
- Four Quadrant Multiplication
- On-Chip Latches for Both DACs
- +10.8 V to +15.75 V Operation
- Low Power Consumption
- TTL/5V CMOS Compatible
- Latch-Up Free
- Second Source to AD7628
- 5 V Operation: MP7529B

#### **BENEFITS**

- Quiet Operation in Audio Applications
- Easy Interface to Microprocessors

#### **GENERAL DESCRIPTION**

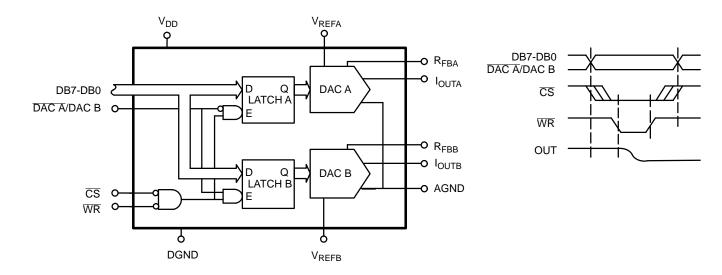
The MP7529A is a dual 8-bit Digital-to-Analog Converter featuring excellent DAC-to-DAC matching, tracking and specifically optimized for applications requiring low total harmonic distortion. The MP7529A is manufactured using advanced thin film resistors on a double metal CMOS process. The MP7529A incorporates a unique decoding technique yielding lower glitch energy, higher speed and excellent accuracy over temperature and time.

Data is transferred to either of the two D/A Converter latches via a common 8-bit TTL/5 V CMOS compatible input port. The control input  $\overline{\text{DAC A}}/\text{DAC B}$  determines which DAC is to be loaded.

The device is specified for operation from +10.8 V to +15.75 V power supply, and is TTL-compatible over this range. Power dissipation is only 20 mW. Both DACs offer excellent four quadrant multiplication characteristics, and include separate reference inputs and feedback resistors. An improved latch-up resistant design eliminates the need for external protective Schottky diodes in most applications.

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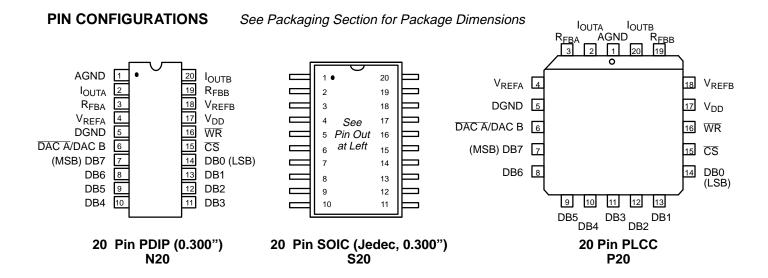
# SIMPLIFIED BLOCK AND TIMING DIAGRAM





### ORDERING INFORMATION

Package Type	Temperature Range	Part No.	INL (LSB)	DNL (LSB)	Gain Error (LSB)
Plastic Dip	–40 to +85°C	MP7529AJN	<u>+</u> 1	<u>+</u> 1	<u>+</u> 5
Plastic Dip	–40 to +85°C	MP7529AKN	<u>+</u> 1/2	<u>+</u> 1	<u>+</u> 3
SOIC	–40 to +85°C	MP7529AJS	<u>+</u> 1	<u>+</u> 1	<u>+</u> 5
SOIC	–40 to +85°C	MP7529AKS	<u>+</u> 1/2	<u>+</u> 1	<u>+</u> 3
PLCC	–40 to +85°C	MP7529AJP	<u>+</u> 1	<u>+</u> 1	<u>+</u> 5
PLCC	–40 to +85°C	MP7529AKP	<u>+</u> 1/2	<u>+</u> 1	<u>+</u> 3



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#### PIN OUT DEFINITIONS

PIN NO.	NAME	DESCRIPTION
1	AGND	Analog Ground
2	I <sub>OUTA</sub>	Current Output of DAC A
3	R <sub>FBA</sub>	Internal Feedback Resistor of DAC A
4	$V_{REFA}$	Reference Input Voltage of DAC A
5	DGND	Digital Ground
6	DAC A/ DAC B	DAC selection control
7	DB7	Data Input Input Bit 7 (MSB)
8	DB6	Data Input Bit 6
9	DB5	Data Input Bit 5
10	DB4	Data Input Bit 4

PIN NO.	NAME	DESCRIPTION
11	DB3	Data Input Bit 3
12	DB2	Data Input Bit 2
13	DB1	Data Input Bit 1
14	DB0	Data Input Bit 0 (LSB)
15	CS	Chip Select (Active Low)
16	WR	Write Enable (Active Low)
17	$V_{DD}$	Power Supply
18	$V_{REFB}$	Reference Input Voltage of DAC B
19	R <sub>FBB</sub>	Internal Feedback Resistor of DAC B
20	I <sub>OUTB</sub>	Current Output of DAC B

**TQM** 



# **ELECTRICAL CHARACTERISTICS**

 $(V_{DD} = +10.8 \text{ V to } +15.75, V_{REF} = +10 \text{ V unless otherwise noted})$ 

			25°C		Tmin to	Tmax		
Parameter	Symbol	Min	Тур	Max	Min	Max	Units	Test Conditions/Comments
STATIC PERFORMANCE <sup>1</sup>								
Resolution (All Grades)	N	8			8		Bits	
Integral Non-Linearity (Relative Accuracy)	INL			,			LSB	End Point Linearity Spec.
J K				<u>+</u> 1 <u>+</u> 1/2		<u>+</u> 1 <u>+</u> 1/2		
Differential Non-Linearity J K	DNL			<u>+</u> 1 <u>+</u> 1		<u>+</u> 1 <u>+</u> 1	LSB	All grades monotonic over full temperature range.
Gain Error J K	GE			<u>+</u> 4 <u>+</u> 2		<u>+</u> 5 <u>+</u> 3	LSB	Using Internal R <sub>FB</sub>
Gain Temperature Coefficient <sup>2</sup>	TC <sub>GE</sub>		<u>+</u> 15			<u>+</u> 35	ppm/°C	$\Delta$ Gain/ $\Delta$ Temperature
Power Supply Rejection Ratio	PSRR			<u>+</u> 100		<u>+</u> 200	ppm/%	$ \Delta Gain/\Delta V_{DD} , \Delta V_{DD} = \pm 5\%$ $V_{DD} = 10.8 \text{ V}, \pm 5\%, \& 15.75 \text{ V} \pm 5\%$
Output Leakage Current	I <sub>LKG</sub>			<u>+</u> 50		<u>+</u> 200	nA	
DYNAMIC PERFORMANCE <sup>2</sup>								
Harmonic Distortion Digital Crosstalk AC Feedthrough VREFA to IOUTA VREFB to IOUTB Channel-to-Channel Isolation VREFA to IOUTB VREFB to IOUTA Glitch Energy Current Settling Time Propagation Delay  REFERENCE INPUT	THD Q FT FTA FTB CCI CCIBA CCIAB Egl ts tpD		-95 30 -70 -70 -77 -77 10 200 100			-65 -65 250 150	dB nVs dB dB dB dB dB nVs ns ns	$V_{IN}$ = 6 $V_{RMS}$ @ 1 kHz  All zeros to all ones Input Change To 1/2 LSB,R <sub>L</sub> =100 $\Omega$ , C <sub>EXT</sub> =13pF From 50% of digital input to 90% of final analog output current R <sub>L</sub> =100 $\Omega$ , C <sub>EXT</sub> =13pF
Input Resistance Input Resistance Matching	R <sub>IN</sub>	8		15 <u>+</u> 1	8	15 <u>+</u> 1	kΩ %	
DIGITAL INPUTS <sup>3</sup>								
Logical "1" Voltage Logical "0" Voltage Input Leakage Current Input Capacitance <sup>2</sup>	V <sub>IH</sub> V <sub>IL</sub> I <sub>LKG</sub>	3.0	2.4	0.8 <u>+</u> 1	3.0	0.8 <u>+</u> 10	V V μΑ	
Data Control	C <sub>IN</sub> C <sub>IN</sub>			10 15		10 15	pF pF	



# **ELECTRICAL CHARACTERISTICS (CONT'D)**

Parameter	Symbol	Min	25°C Typ	Max	Tmin to Min	Tmax Max	Units	Test Conditions/Comments
ANALOG OUTPUTS <sup>2</sup>								
Output Capacitance								
	C <sub>OUTA/B</sub>			120		120	pF	DAC inputs all 1's
	C <sub>OUTA/B</sub>			50		50	pF	DAC inputs all 0's
POWER SUPPLY <sup>1</sup>								
Supply Current	$I_{DD}$			1		1	mA	All digital inputs = 0 V, or all = 5 V
				2		2	mA	All digital inputs = $V_{IL}$ , or all = $V_{IH}$
TIMING SPECIFICATIONS <sup>4</sup>								
Chip Select to Write Set-Up Time	t <sub>CS</sub>	60			80		ns	
Chip Select to Write Hold Time	t <sub>CH</sub>	15			20		ns	
DAC Select to Write Set-Up Time	t <sub>AS</sub>	60			80		ns	
DAC Select to Write Hold Time	$t_{AH}$	15			20		ns	
Data Valid to Write Set-Up Time	t <sub>DS</sub>	60			80		ns	
Data Valid to Write Hold Time	t <sub>DH</sub>	0			0		ns	
Write Pulse Width <sup>5</sup>	t <sub>WR</sub>	60			80		ns	

#### NOTES:

- <sup>1</sup> Full Scale Range (FSR) is 10V for unipolar mode.
- 2 Guaranteed but not production tested.
- Digital input levels should not go below ground or exceed the positive supply voltage, otherwise damage may occur.
- <sup>4</sup> See timing diagram Figure 1.
- $t_{WR} = 40$ ns minimum if  $t_{DH} > 15$ ns (@T = 25°C).

### Specifications are subject to change without notice

# WWW.DABSOLUTE MAXIMUM RATINGS (TA = +25°C unless otherwise noted)<sup>1, 2, 3</sup>

V <sub>RFBA</sub> , V <sub>RFBB</sub> to GND
Storage Temperature65°C to +150°C
Lead Temperature (Soldering, 10 seconds) +300°C
Package Power Dissipation Rating to 75°C
PDIP, SOIC, PLCC 900mW
Derates above 75°C 12mW/°C

#### NOTES:

- Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation at or above this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.
- Any input pin which can see a value outside the absolute maximum ratings should be protected by Schottky diode clamps (HP5082-2835) from input pin to the supplies. All inputs have protection diodes which will protect the device from short transients outside the supplies of less than 100mA for less than 100μs.

3 GND refers to AGND and DGND.

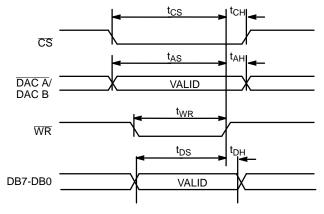




#### **DIGITAL INTERFACE**

The digital inputs are designed to be both TTL and 5 V CMOS compatible. All logic inputs are static protected MOS gates with typical input currents of less than 10nA.

The control input DAC A/DAC B selects which DAC can accept data from the input port. Inputs CS and WR control the operating mode of the selected DAC (Table 1.). When CS and WR are both low the selected DAC is in the write mode. The input data latches of the selected DAC are transparent and its analog output responds to activity on DB0-DB7 (Write mode). The selected DAC latch retains the data which was present on DB0-DB7 just prior to  $\overline{\text{CS}}$  or  $\overline{\text{WR}}$  assuming a high state. Both analog outputs remain at the values corresponding to the data in their respective latches (Hold mode).



L L L WRITE H L L HOLD X H X HOLD X X H HOLD	HOLD WRITE HOLD HOLD

L = Low State H = High State X = Don't Care

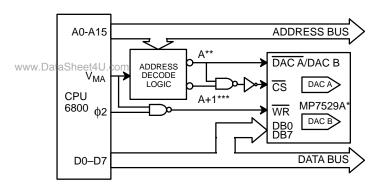
#### NOTE:

1. Timing measured from (V<sub>IH</sub> + V<sub>II</sub> ) /2

Figure 1. Write Cycle Timing Diagram

#### Table 1. DACs Mode Selection

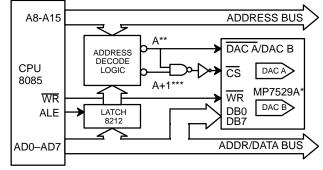
#### MICROPROCESSOR INTERFACE



- \*Analog circuitry has been omitted for clarity
- \*\*A = Decoded 7529A DAC A Address
- \*\*\*A+1 = Decoded 7529A DAC B Address

Figure 2. MP7529A Dual DAC to 6800 **CPU Interface** 

8085 instruction shld (store H & L direct) can update both DACS with data from H and L registers



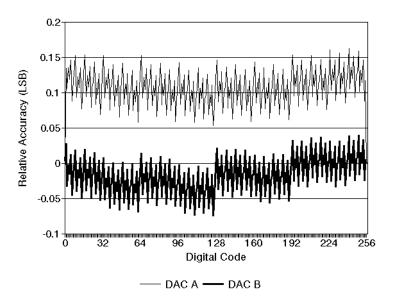
- \*Analog circuitry has been omitted for clarity
- \*\*A = Decoded 7529A DAC A Address
- \*\*\*A+1 = Decoded 7529A DAC B Address

Figure 3. MP7529A Dual DAC to 8085 **CPU Interface** 





# PERFORMANCE CHARACTERISTICS

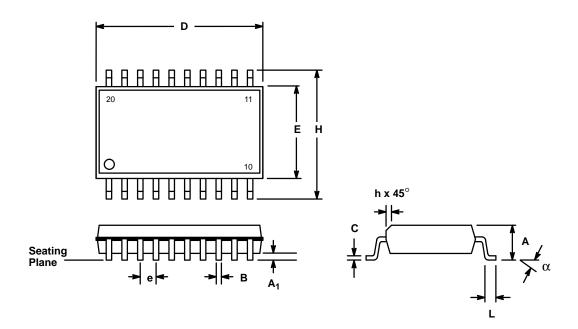


Graph 1. Relative Accuracy vs. Digital Code

APPLICATION NOTES
Refer to Section 8 for Applications Information



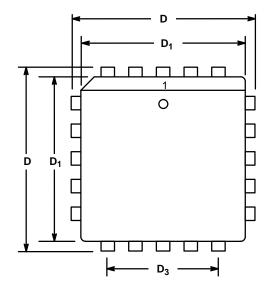
# 20 LEAD SMALL OUTLINE (300 MIL JEDEC SOIC) S20

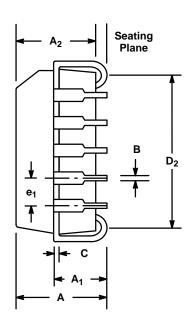


	INC	CHES	MILLIN	METERS
SYMBOL	MIN	MAX	MIN	MAX
А	0.097	0.104	2.464	2.642
A <sub>1</sub>	0.0050	0.0115	0.127	0.292
В	0.014	0.019	0.356	0.483
С	0.0091	0.0125	0.231	0.318
D	0.500	0.510	12.70	12.95
Е	0.292	0.299	7.42	7.59
е	0.0	50 BSC	1.2	7 BSC
Н	0.400	0.410	10.16	10.41
h	0.010	0.016	0.254	0.406
L	0.016	0.035	0.406	0.889
α	0°	8°	0°	8°



# 20 LEAD PLASTIC LEADED CHIP CARRIER (PLCC) P20





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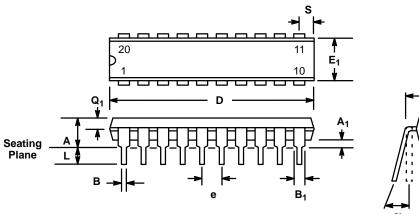
	INC	CHES	MILLI	METERS
SYMBOL	MIN	MAX	MIN	MAX
А	0.165	0.180	4.19	4.57
A <sub>1</sub>	0.100	0.110	2.54	2.79
A <sub>2</sub>	0.148	0.156	3.76	3.96
В	0.013	0.021	0.330	0.533
С	0.008	0.012	0.203	0.305
D	0.385	0.395	9.78	10.03
D <sub>1</sub> (1)	0.350	0.354	8.89	8.99
D <sub>2</sub>	0.290	0.330	7.37	8.38
$D_3$	0.2	00 Ref	5.0	8 Ref.
e <sub>1</sub>	0.0	50 BSC	1.2	7 BSC

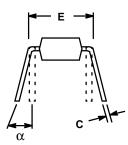
 $\begin{array}{ccc} \text{Note:} & \text{(1)} & \text{Dimension D}_1 \text{ does not include mold protrusion.} \\ & \text{Allowed mold protrusion is 0.254 mm/0.010 in.} \end{array}$ 





# 20 LEAD PLASTIC DUAL-IN-LINE (300 MIL PDIP) N20





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	INC	HES	MILLIN	METERS
SYMBOL	MIN	MAX	MIN	MAX
А	_	0.200	_	5.08
A <sub>1</sub>	0.015	_	0.38	_
В	0.014	0.023	0.356	0.584
B <sub>1</sub> (1)	0.038	0.065	0.965	1.65
С	0.008	0.015	0.203	0.381
D	0.945	1.060	24.0	26.92
Е	0.295	0.325	7.49	8.26
E <sub>1</sub>	0.220	0.310	5.59	7.87
е	0.10	0.100 BSC		4 BSC
L	0.115	0.150	2.92	3.81
α	0°	15°	0°	15°
Q <sub>1</sub>	0.055	0.070	1.40	1.78
S	0.040	0.080	1.02	2.03

Note: (1) The minimum limit for dimensions B1 may be 0.023" (0.58 mm) for all four corner leads only.



# **Notes**





# **Notes**





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